

**DESCRIPTION** 

5 kV/µs.

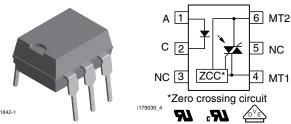
packaged in a DIP-6 package.

for bin H, and 3 mA for bin M.

www.vishay.com

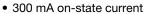
Vishay Semiconductors

## Optocoupler, Phototriac Output, Zero Crossing, High dV/dt, Low Input Current



### **FEATURES**

- High static dV/dt 5 kV/µs
- High input sensitivity I<sub>FT</sub> = 1.6 mA, 2 mA, and



- Zero voltage crossing detector
- 700 V and 800 V blocking voltage
- Isolation test voltage 5300 V<sub>RMS</sub>
- Compliant to RoHS Directive 2011/65/EU

#### **APPLICATIONS**

- Solid-state relays
- · Industrial controls
- Office equipment
- Consumer appliances

#### **AGENCY APPROVALS**

- UL1577, file no. E52744 system code H or J, double protection
- cUL file no. E52744, equivalent to CSA bulletin 5A
- DIN EN 60747-5-2 (VDE 0884) available with option 1
- FIMKO

## 21842-1

The VO4157 and VO4158 consists of a GaAs IRLED

optically coupled to a photosensitive zero crossing TRIAC

High input sensitivity is achieved by using an emitter follower phototransistor and a cascaded SCR predriver

resulting in an LED trigger current of 1.6 mA for bin D, 2 mA

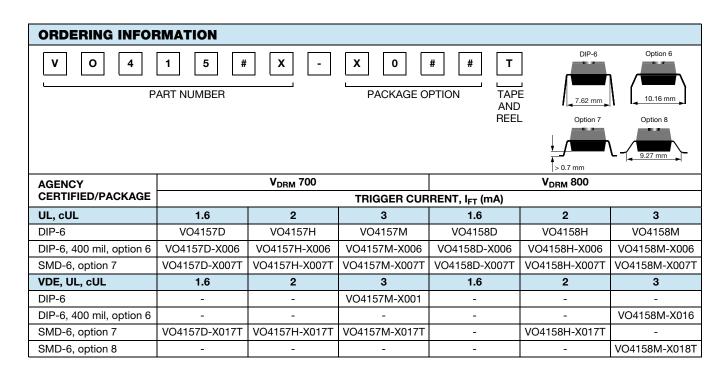
The new phototriac zero crossing family uses a proprietary dV/dt clamp resulting in a static dV/dt of greater than

The VO4157 and VO4158 isolates low-voltage logic from

120  $V_{AC}$ , 240  $V_{AC}$ , and 380  $V_{AC}$  lines to control resistive,

inductive, or capacitive loads including motors, solenoids,

high current thyristors or TRIAC and relays.





<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT		
INPUT	·						
Reverse voltage			$V_{R}$	6	V		
Forward current			I <sub>F</sub>	60	mA		
Surge current			I <sub>FSM</sub>	2.5	Α		
Derate from 25 °C				1.33	mW/°C		
OUTPUT							
Poak off state voltage		VO4157D/H/M	$V_{DRM}$	700	V		
Peak off-state voltage		VO4158D/H/M	$V_{DRM}$	800	V		
RMS on-state current			I <sub>TM</sub>	300	mA		
Derate from 25 °C				6.6	mW/°C		
COUPLER							
Isolation test voltage (between emitter and detector, climate per DIN 500414, part 2, Nov. 74)	t = 1 min		$V_{ISO}$	5300	$V_{RMS}$		
Storage temperature range			T <sub>stg</sub>	- 55 to + 150	°C		
Ambient temperature range			T <sub>amb</sub>	- 55 to + 100	°C		
Soldering temperature	max. ≤ 10 s dip soldering ≥ 0.5 mm from case bottom		T <sub>sld</sub>	260	°C		

#### Note

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
maximum ratings for extended periods of the time can adversely affect reliability.
 This phototriac should not be used to drive a load directly. It is intended to be a trigger device only.

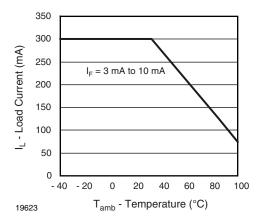


Fig. 1 - Recommended Operating Condition



THERMAL CHARACTERISTICS			
PARAMETER	SYMBOL	VALUE	UNIT
LED power dissipation	P <sub>diss</sub>	100	mW
Output power dissipation	P <sub>diss</sub>	500	mW
Total power dissipation	P <sub>tot</sub>	600	mW
Maximum LED junction temperature	T <sub>jmax.</sub>	125	°C
Maximum output die junction temperature	T <sub>jmax.</sub>	125	°C
Thermal resistance, junction emitter to board	$\theta_{JEB}$	150	°C/W
Thermal resistance, junction emitter to case	$\theta_{JEC}$	139	°C/W
Thermal resistance, junction detector to board	$\theta_{JDB}$	78	°C/W
Thermal resistance, junction detector to case	$\theta_{JDC}$	103	°C/W
Thermal resistance, junction emitter to junction detector	$\theta_{JED}$	496	°C/W
Thermal resistance, case to ambient	$\theta_{CA}$	3563	°C/W

#### Note

The thermal characteristics table above were measured at 25 °C and the thermal model is represented in the thermal network below. Each
resistance value given in this model can be used to calculate the temperatures at each node for a given operating condition. The thermal
resistance from board to ambient will be dependent on the type of PCB, layout and thickness of copper traces. For a detailed explanation
of the thermal model, please reference Vishay's Thermal Characteristics of Optocouplers application note.

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT					•		
Forward voltage	I <sub>F</sub> = 10 mA		V <sub>F</sub>		1.2	1.4	V
Reverse current	V <sub>R</sub> = 6 V		I <sub>R</sub>		0.1	10	μΑ
Input capacitance	$V_F = 0 V, f = 1 MHz$		C <sub>I</sub>		25		pF
OUTPUT							
Repetitive peak off-state voltage	I <sub>DRM</sub> = 100 μA	VO4157D/H/M	$V_{DRM}$	700			V
		VO4158D/H/M	$V_{DRM}$	800			V
Off-state current	$V_D = V_{DRM, I_F} = 0$		I <sub>DRM</sub>			100	μΑ
On-state voltage	$I_T = 300 \text{ mA}$		$V_{TM}$			3	V
On-state current	PF = 1, V <sub>T(RMS)</sub> = 1.7 V		I <sub>TM</sub>			300	mA
Off-state current in inhibit state	$I_F = 2 \text{ mA}, V_{DRM}$		I <sub>DINH</sub>			200	μΑ
Holding current			I <sub>H</sub>			500	μΑ
Zero cross inhibit voltage	$I_F$ = rated $I_{FT}$		V <sub>IH</sub>			20	V
Critical rate of rise of off-state voltage	V <sub>D</sub> = 0.67 V <sub>DRM</sub> , T <sub>J</sub> = 25 °C		dV/dt <sub>cr</sub>	5000			V/µs
COUPLER							
LED trigger current, current required to latch output	V <sub>D</sub> = 3 V	VO4157D	I <sub>FT</sub>			1.6	mA
		VO4157H	I <sub>FT</sub>			2	mA
		VO4157M	I <sub>FT</sub>			3	mA
		VO4158D	I <sub>FT</sub>			1.6	mA
		VO4158H	I <sub>FT</sub>			2	mA
		VO4158M	I <sub>FT</sub>			3	mA
Common mode coupling capacitance			C <sub>CM</sub>		0.01		pF
Capacitance (input to output)	f = 1 MHz, V <sub>IO</sub> = 0 V		C <sub>IO</sub>		0.8		pF

#### Note

Minimum and maximum values were tested requierements. Typical values are characteristics of the device and are the result of engineering
evaluations. Typical values are for information only and are not part of the testing requirements.



SAFETY AND INSULATION RATINGS								
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Climatic classification (according to IEC68 part 1)				55/100/21				
Pollution degree (DIN VDE 0109)				2				
Comparative tracking index per DIN IEC112/VDE 0303 part 1, group IIIa per DIN VDE 6110 175 399			175		399			
V <sub>ІОТМ</sub>		V <sub>IOTM</sub>	8000			V		
V <sub>IORM</sub>		V <sub>IORM</sub>	890			V		
P <sub>SO</sub>		P <sub>SO</sub>			500	mW		
I <sub>SI</sub>		I <sub>SI</sub>			250	mA		
$T_{SI}$		T <sub>SI</sub>			175	°C		
Creepage distance			7			mm		

### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

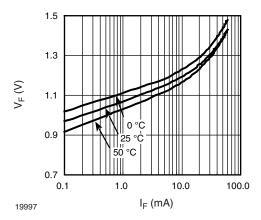


Fig. 2 - Diode Forward Voltage vs. Forward Current

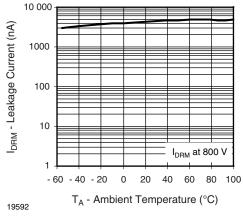


Fig. 4 - Leakage Current vs. Ambient Temperature

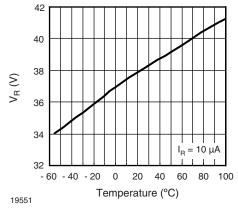


Fig. 3 - Diode Reverse Voltage vs. Temperature

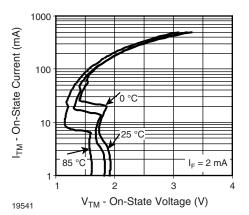


Fig. 5 - On State Current vs. On State Voltage

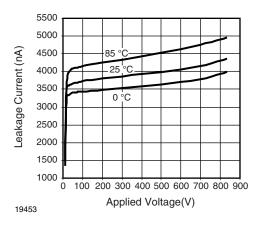


Fig. 6 - Output Off Current (Leakage) vs. Voltage

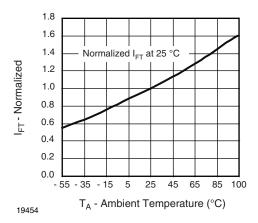


Fig. 7 - Normalized Trigger Input Current vs. Temperature

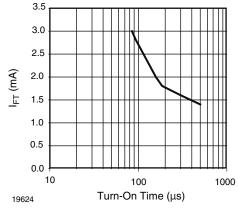


Fig. 8 - Trigger Current vs. Turn-On Time

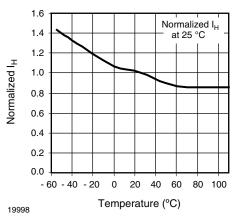


Fig. 9 - Normalized Holding Current vs. Temperature

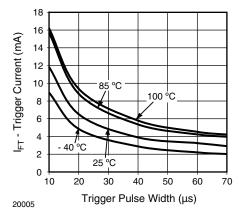


Fig. 10 - I<sub>FT</sub> vs. LED Pulse Width

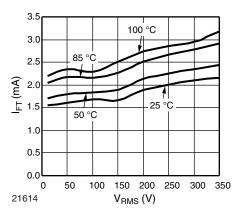


Fig. 11 - I<sub>FT</sub> vs. V<sub>RMS</sub> and Temperature



# Control 2 220/240 VAC U1 R<sub>a</sub> 330 Inductive load Nutral

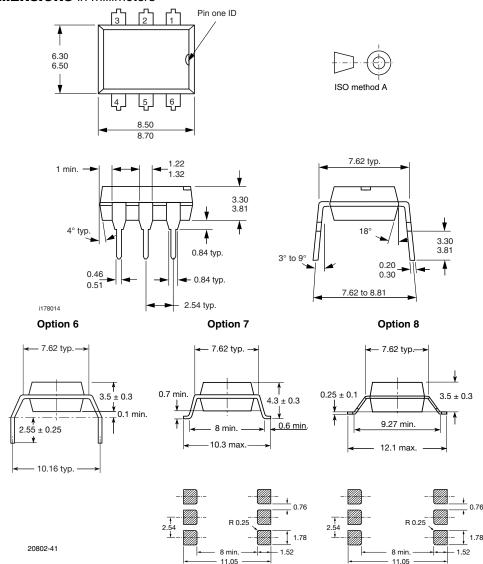
Fig. 12 - Basic Power Triac Driver Circuit

#### **POWER FACTOR CONSIDERATIONS**

As a zero voltage crossing optotriac, the commutating dV/dt spikes can inhibit one half of the TRIAC from turning on. If the spike potential exceeds the inhibit voltage of the zero-cross detection circuit, half of the TRIAC will be held-off and not turn-on. This hold-off condition can be eliminated by using a capacitor or RC snubber placed directly across the power triac as shown in fig. 11. Note that the value of the capacitor increases as a function of the load current.

The hold-off condition also can be eliminated by providing a higher level of LED drive current. The higher LED drive provides a larger photocurrent which causes the phototransistor to turn-on before the commutating spike has activated the zero-cross detection circuit. For example, if a device requires 1.5 mA for a resistive load, then 2.7 mA (1.8 times) may be required to control an inductive load whose power factor is less than 0.3.

## **PACKAGE DIMENSIONS** in millimeters





### **PACKAGE MARKING** (example)



#### Notes

• VDE logo is only marked on option 1 parts. Tape and reel suffix (T) is not part of the package marking.



## **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.